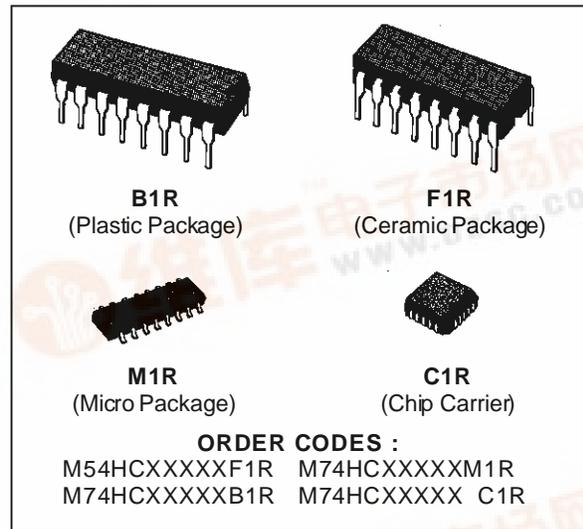




M54/74HC40102
M54/74HC40103

8 STAGE PRESETTABLE SYNCHRONOUS DOWN COUNTERS

- HIGH SPEED
f_{MAX} = 40 MHz (TYP.) at V_{CC} = 5 V
- LOW POWER DISSIPATION
I_{CC} = 4 μA (MAX.) at T_A = 25 °C
- HIGH NOISE IMMUNITY
V_{NIH} = V_{NIL} = 28 % V_{CC} (MIN.)
- OUTPUT DRIVE CAPABILITY
10 LSTTL LOADS
- SYMMETRICAL OUTPUT IMPEDANCE
|I_{OH}| = I_{OL} = 4 mA (MIN.)
- BALANCED PROPAGATION DELAYS
t_{PLH} = t_{PHL}
- WIDE OPERATING VOLTAGE RANGE
V_{CC} (OPR) = 2 V to 6 V
- PIN AND FUNCTION COMPATIBLE WITH
40102B/40103B

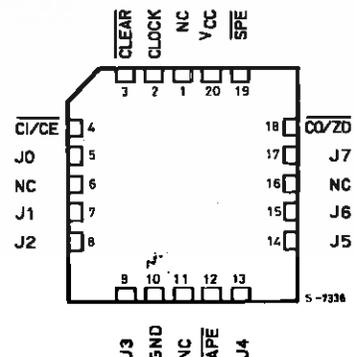
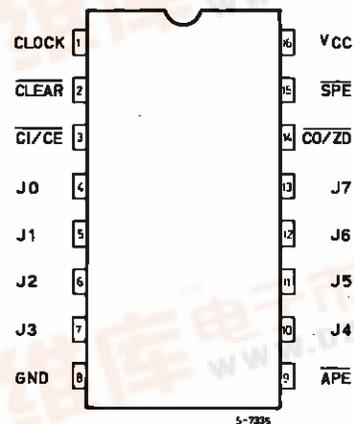


DESCRIPTION

The M54/74HC40102/40103 are high speed CMOS 8-STAGE PRESETTABLE SYNCHRONOUS DOWN COUNTERS fabricated with silicon gate C²MOS technology. They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The HC40102, and HC40103 consist of an 8-stage synchronous down counter with a single output which is active when the internal count is zero. The HC40102 is configured as two cascaded 4-bit BCD counters, and the HC40103 contains a single 8-bit binary counter. Each type has control inputs for enabling or disabling the clock, for clearing the counter to its maximum count, and for presetting the counter either synchronously or asynchronously. All control inputs and the CARRY-OUT/ZERO-DETECT output are active-low logic. In normal operation, the counter is decremented by one count on each positive transition of the CLOCK. Counting is inhibited when the CARRY-IN/COUNTER ENABLE (CI/CE) input is high. The CARRY-OUT/ZERO-DETECT (CO/ZD) output goes low when the count reaches zero if the CI/CE input is low, and remains low for one full clock period. When the SYNCHRONOUS PRESET-ENABLE (SPE) input is low, data at the J input is clocked into the counter on the next positive clock transition regardless of the state of the CI/CE input.

PIN CONNECTIONS (top view)



NC =
No Internal
Connection

M54/M74HC40102/40103

DESCRIPTION (Continued)

When the ASYNCHRONOUS PRESET-ENABLE (APE) input is low, data at the J inputs is asynchronously forced into the counter regardless of the state of the SPE, CI/CE, or CLOCK inputs. J Inputs J0-J7 represent two 4-bit BCD words for the HC40102 and a single 8-bit binary word for the HC40103. When the CLEAR (CLR) input is low, the counter is asynchronously cleared to its maximum count (99₁₀ for the HC40102 and 255₁₀ for the HC40103 regardless of the state of any other input. The precedence

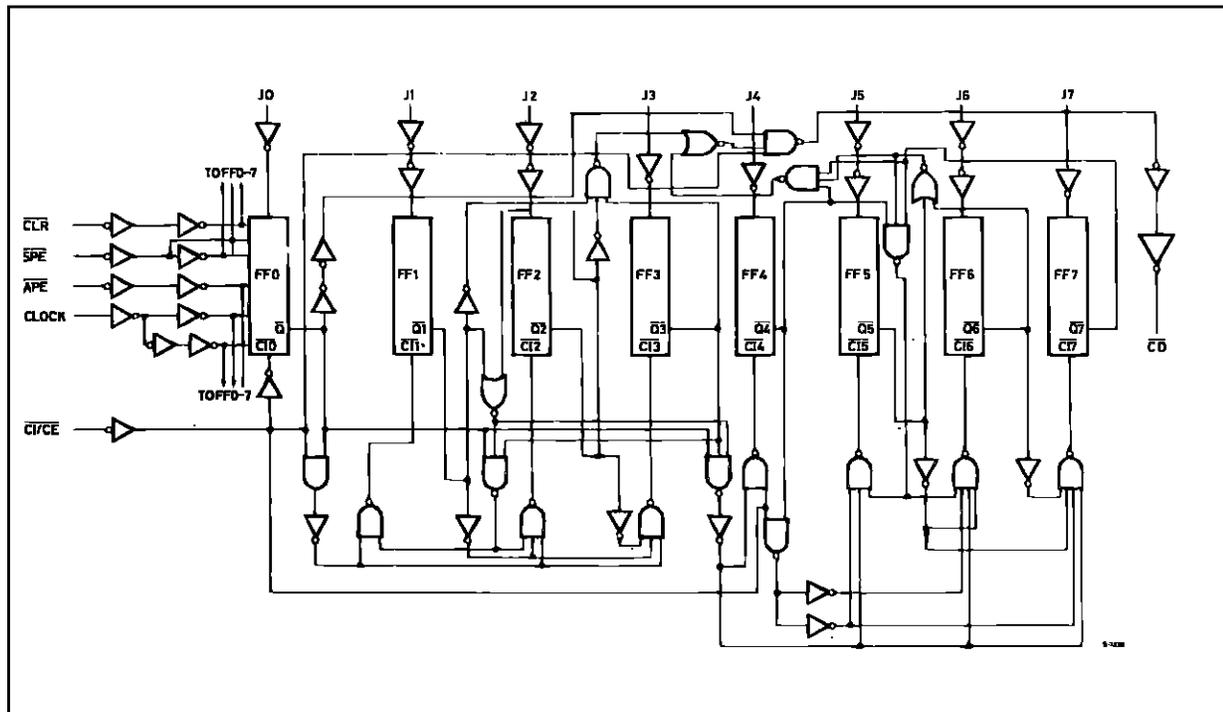
relationship between control input is indicated in the truth table. If all control inputs are high at the time of zero count, the counters will jump to the maximum count, giving a counting sequence of 100 or 256 clock pulses long. The HC40102 and HC40103 may be cascaded using the CI/CE input and the CO/ZD output, in either a synchronous or ripple mode. All inputs are equipped with protection circuits against static discharge and transient excess voltage.

TRUTH TABLE

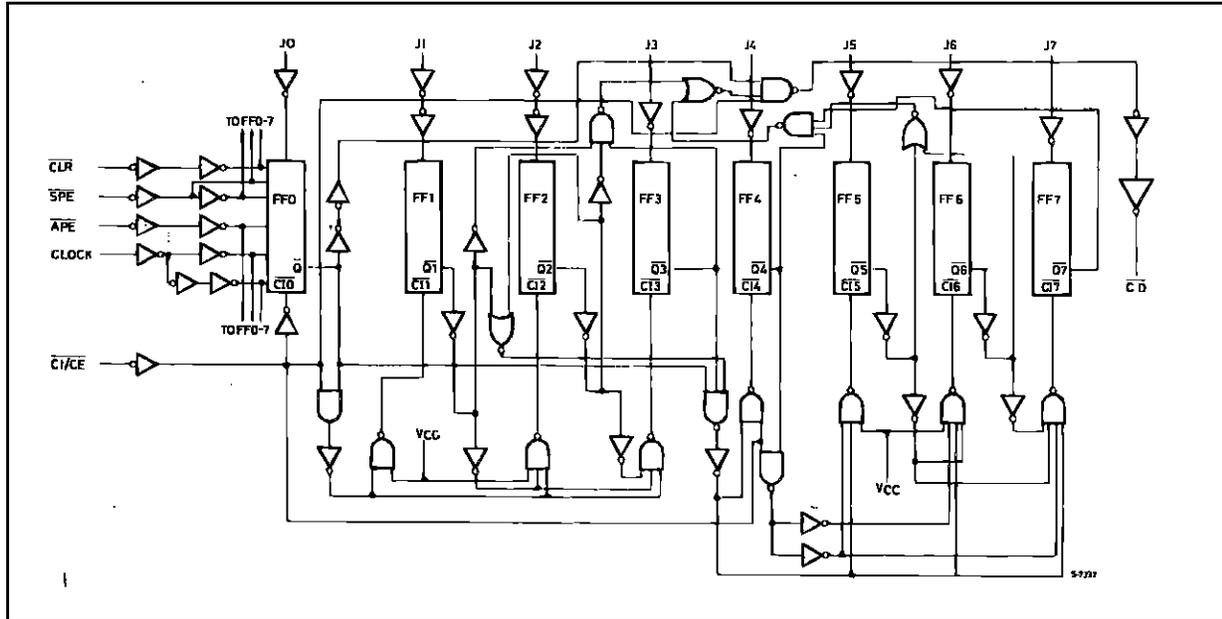
CONTROL INPUTS				MODE	FUNCTIONAL DESCRIPTION
CLR	APE	SPE	CI/CE		
H	H	H	H	COUNT INHIBIT	EVEN IF CLOCK IS GIVEN, NO COUNT IS MADE
H	H	H	L	REGULAR COUNT	DOWN COUNT AT RISING EDGE OF CLOCK
H	H	L	X	SYNCHRONOUS PRESET	DATA OF PI TERMINAL IS PRESET AT RISING EDGE OF CLOCK
H	L	X	X	ASYNCHRONOUS PRESET	DATA OF PI TERMINAL IS ASYNCHRONOUSLY PRESET TO CLOCK
L	X	X	X	CLEAR	COUNTER IS SET TO MAXIMUM COUNT

X: DON'T CARE - MAXIMUM COUNT: "99" FOR HC40102 AND "255": FOR HC40103

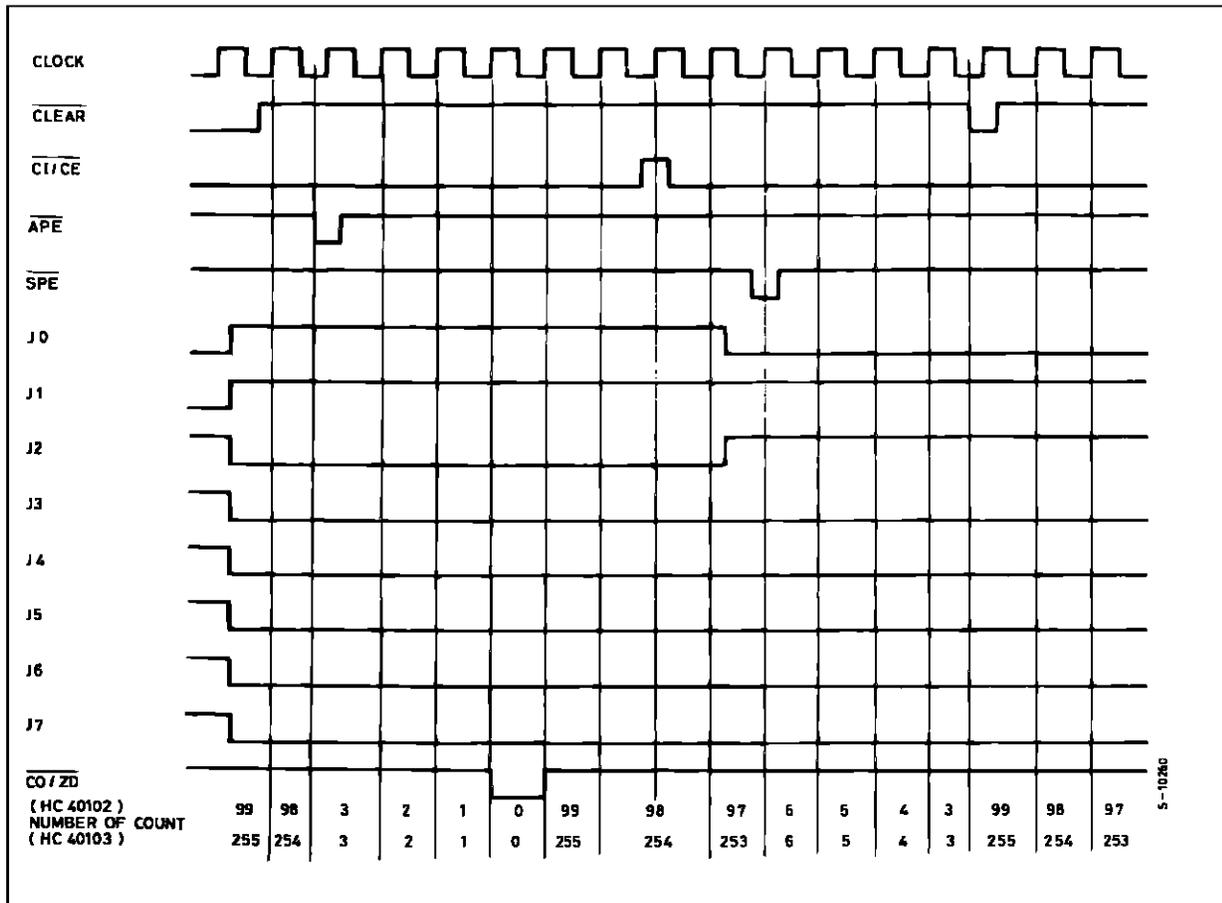
LOGIC DIAGRAM (HC40102)



LOGIC DIAGRAM (HC40103)



TIMING CHART

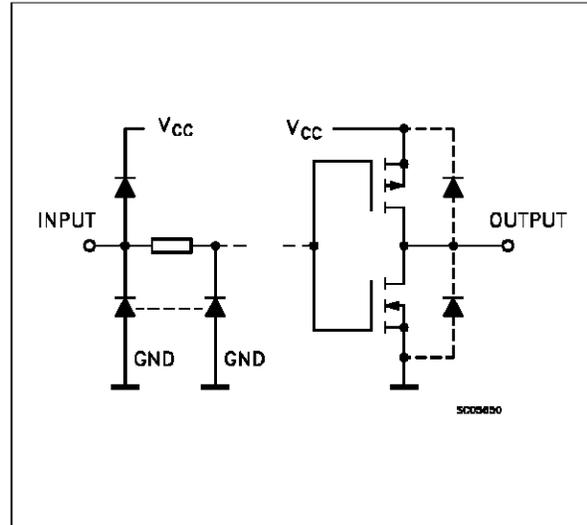


M54/M74HC40102/40103

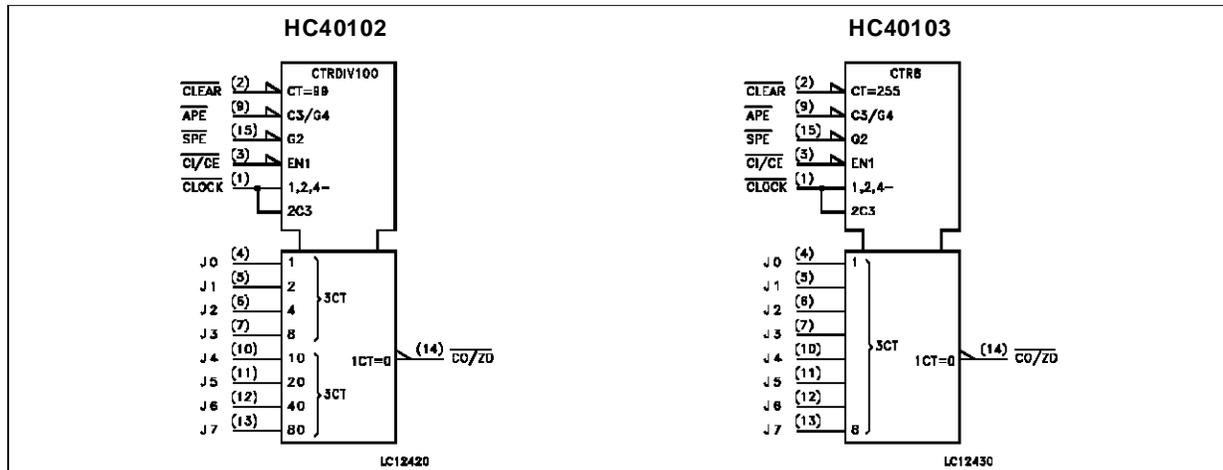
PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1	CLOCK	CLock Input (LOW to HIGH edge triggered)
2	$\overline{\text{CLEAR}}$	Asynchronous Master Reset Input (Active LOW)
3	$\overline{\text{CI/CE}}$	Terminal Enable Input
4, 5, 6, 7, 10, 11, 12, 13	J0 to J9	Jam Inputs
9	$\overline{\text{APE}}$	Asynchronous Preset Enable Input (Active LOW)
14	$\overline{\text{CO/ZD}}$	Terminal Count Output (Active LOW)
15	$\overline{\text{SPE}}$	Synchronous Preset Enable Input (Active LOW)
8	GND	Ground (0V)
16	V _{CC}	Positive Supply Voltage

INPUT AND OUTPUT EQUIVALENT CIRCUIT



IEC LOGIC SYMBOLS



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	-0.5 to +7	V
V _I	DC Input Voltage	-0.5 to V _{CC} + 0.5	V
V _O	DC Output Voltage	-0.5 to V _{CC} + 0.5	V
I _{IK}	DC Input Diode Current	± 20	mA
I _{OK}	DC Output Diode Current	± 20	mA
I _O	DC Output Source Sink Current Per Output Pin	± 25	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current	± 50	mA
P _D	Power Dissipation	500 (*)	mW
T _{stg}	Storage Temperature	-65 to +150	°C
T _L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

(*) 500 mW: ≡ 65 °C derate to 300 mW by 10mW/°C: 65 °C to 85 °C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit	
V _{CC}	Supply Voltage	2 to 6	V	
V _I	Input Voltage	0 to V _{CC}	V	
V _O	Output Voltage	0 to V _{CC}	V	
T _{op}	Operating Temperature: M54HC Series M74HC Series	-55 to +125 -40 to +85	°C °C	
t _r , t _f	Input Rise and Fall Time	V _{CC} = 2 V V _{CC} = 4.5 V V _{CC} = 6 V	0 to 1000 0 to 500 0 to 400	ns

DC SPECIFICATIONS

Symbol	Parameter	Test Conditions		Value						Unit		
				T _A = 25 °C 54HC and 74HC			-40 to 85 °C 74HC		-55 to 125 °C 54HC			
				Min.	Typ.	Max.	Min.	Max.	Min.		Max.	
V _{IH}	High Level Input Voltage	V _{CC} (V)		1.5			1.5		1.5		V	
				3.15			3.15		3.15			
				4.2			4.2		4.2			
V _{IL}	Low Level Input Voltage	V _{CC} (V)				0.5		0.5		0.5	V	
						1.35		1.35		1.35		
						1.8		1.8		1.8		
V _{OH}	High Level Output Voltage	V _{CC} (V)	V _I = V _{IH} or V _{IL}	I _O = -20 μA	1.9	2.0		1.9		1.9		V
					4.4	4.5		4.4		4.4		
					5.9	6.0		5.9		5.9		
				I _O = -4.0 mA	4.18	4.31		4.13		4.10		
					I _O = -5.2 mA	5.68	5.8		5.63		5.60	
V _{OL}	Low Level Output Voltage	V _{CC} (V)	V _I = V _{IH} or V _{IL}	I _O = 20 μA			0.0	0.1		0.1		0.1
						0.0	0.1		0.1		0.1	
						0.0	0.1		0.1		0.1	
				I _O = 4.0 mA		0.17	0.26		0.33		0.40	
					I _O = 5.2 mA		0.18	0.26		0.33		0.40
I _I	Input Leakage Current	6.0	V _I = V _{CC} or GND				±0.1		±1		±1	μA
I _{CC}	Quiescent Supply Current	6.0	V _I = V _{CC} or GND			4		40		80	μA	

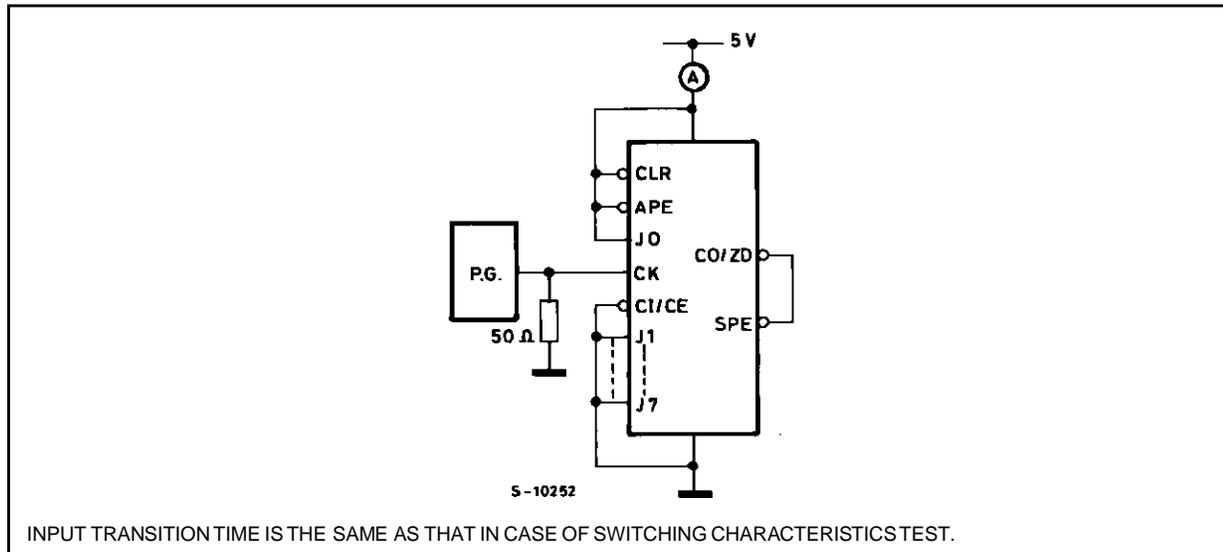
M54/M74HC40102/40103

AC ELECTRICAL CHARACTERISTICS ($C_L = 50\text{ pF}$, Input $t_r = t_f = 6\text{ ns}$)

Symbol	Parameter	Test Conditions		Value						Unit	
		V_{CC} (V)		$T_A = 25\text{ }^\circ\text{C}$ 54HC and 74HC			$-40\text{ to }85\text{ }^\circ\text{C}$ 74HC		$-55\text{ to }125\text{ }^\circ\text{C}$ 54HC		
				Min.	Typ.	Max.	Min.	Max.	Min.		Max.
t_{TLH} t_{THL}	Output Transition Time	2.0			30	75		95		110	ns
		4.5			8	15		19		22	
		6.0			7	13		16		19	
t_{PLH} t_{PHL}	Propagation Delay Time (CK - CO/ZD)	2.0			96	185		230		280	ns
		4.5			24	37		46		56	
		6.0			20	31		39		47	
t_{PLH} t_{PHL}	Propagation Delay Time (APE - CO/ZD)	2.0			116	225		280		340	ns
		4.5			29	45		56		68	
		6.0			25	38		48		57	
t_{PLH} t_{PHL}	Propagation Delay Time (CL - CO/ZD)	2.0			104	200		250		300	ns
		4.5			26	40		50		60	
		6.0			22	34		43		51	
t_{PLH} t_{PHL}	Propagation Delay Time (CI/CE - CO/ZD)	2.0			48	95		120		145	ns
		4.5			12	19		24		29	
		6.0			10	16		20		24	
f_{MAX}	Propagation Delay Time	2.0			4	8		3		2.6	pF
		4.5			20	32		16		13	
		6.0			24	38		19		15	
C_{IN}	Input Capacitance				5	10		10		10	pF
C_{PD} (*)	Power Dissipation Capacitance				60						pF

(*) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

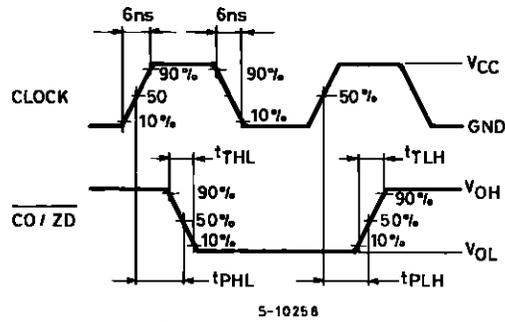
TEST CIRCUIT I_{CC} (Opr.)



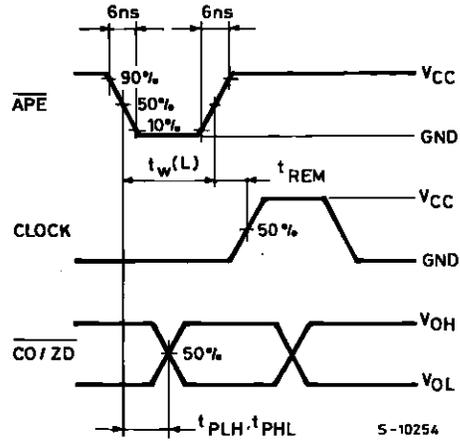
M54/M74HC40102/40103

SWITCHING CHARACTERISTICS TEST WAVEFORM

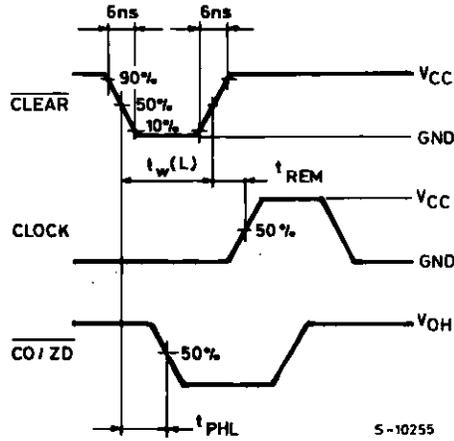
WAVEFORM 1



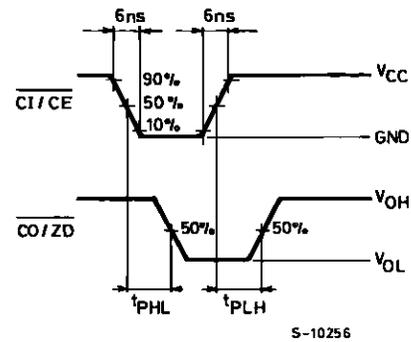
WAVEFORM 2



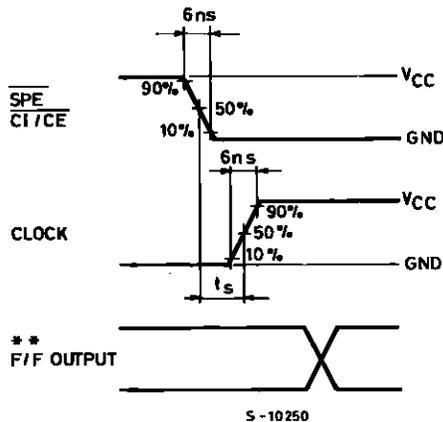
WAVEFORM 3



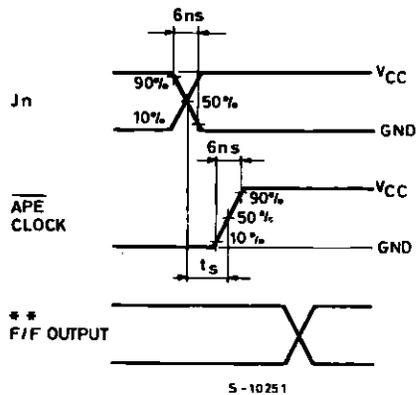
WAVEFORM 4



WAVEFORM 5



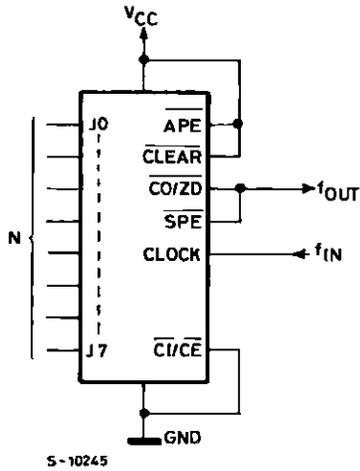
WAVEFORM 6



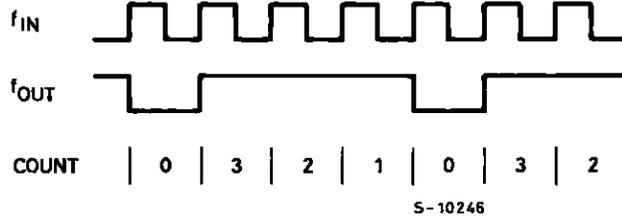
(** F/F output is internal signal of IC)

EXAMPLE OF TYPICAL APPLICATION

PROGRAMMABLE DIVIDE-BY-N COUNTER

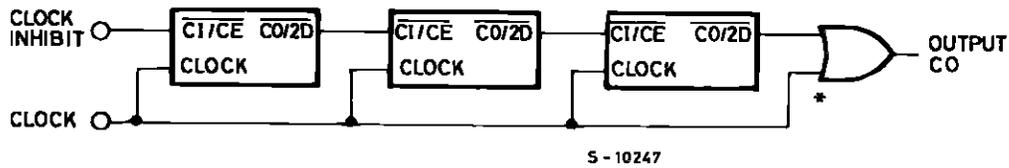


- $f_{OUT} = \frac{f_{IN}}{N+1}$
- Timing chart when N = "3"
(J0, J1 = V_{CC}, J2 - J7 = GND)



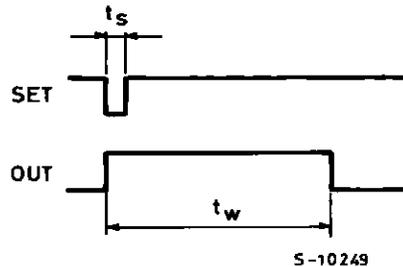
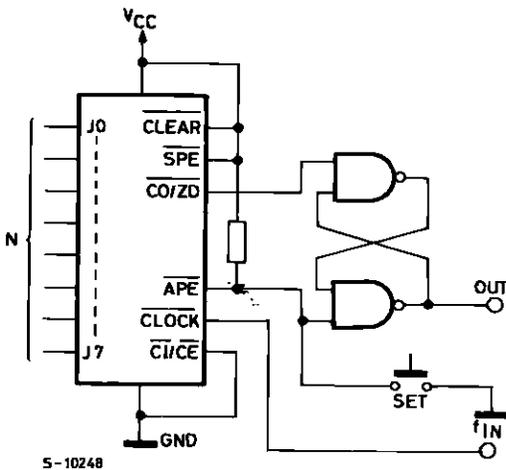
- HC40102... 1/2 to 1/100 are dividable
- HC40103... 1/2 to 1/256 are dividable

PARALLEL CARRY CASCADING



* Asynchronous cascade connection, huzzerd occurs at CO output after its second stage when digit place changes, due to delay arrival. Therefore, take gate from HC32 or the like, not from CO output at the rear stage directly.

PROGRAMMABLE TIMER



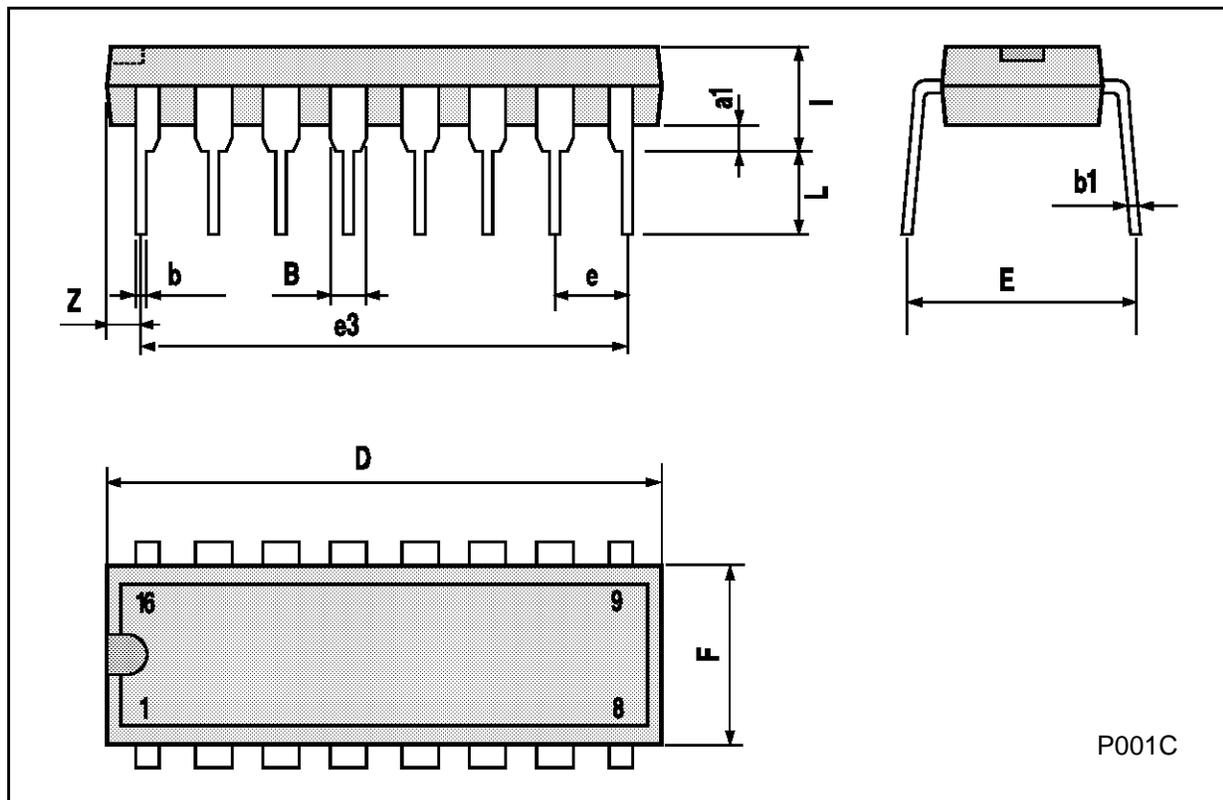
$$t_w = \left(\frac{N}{f_{IN}} + t_s \right)$$

Note :The above formula does not take into account the phase of clock input. Therefore, the real pulse width is the distance between the above formula-1/f_{IN} - the above formula.

M54/M74HC40102/40103

Plastic DIP16 (0.25) MECHANICAL DATA

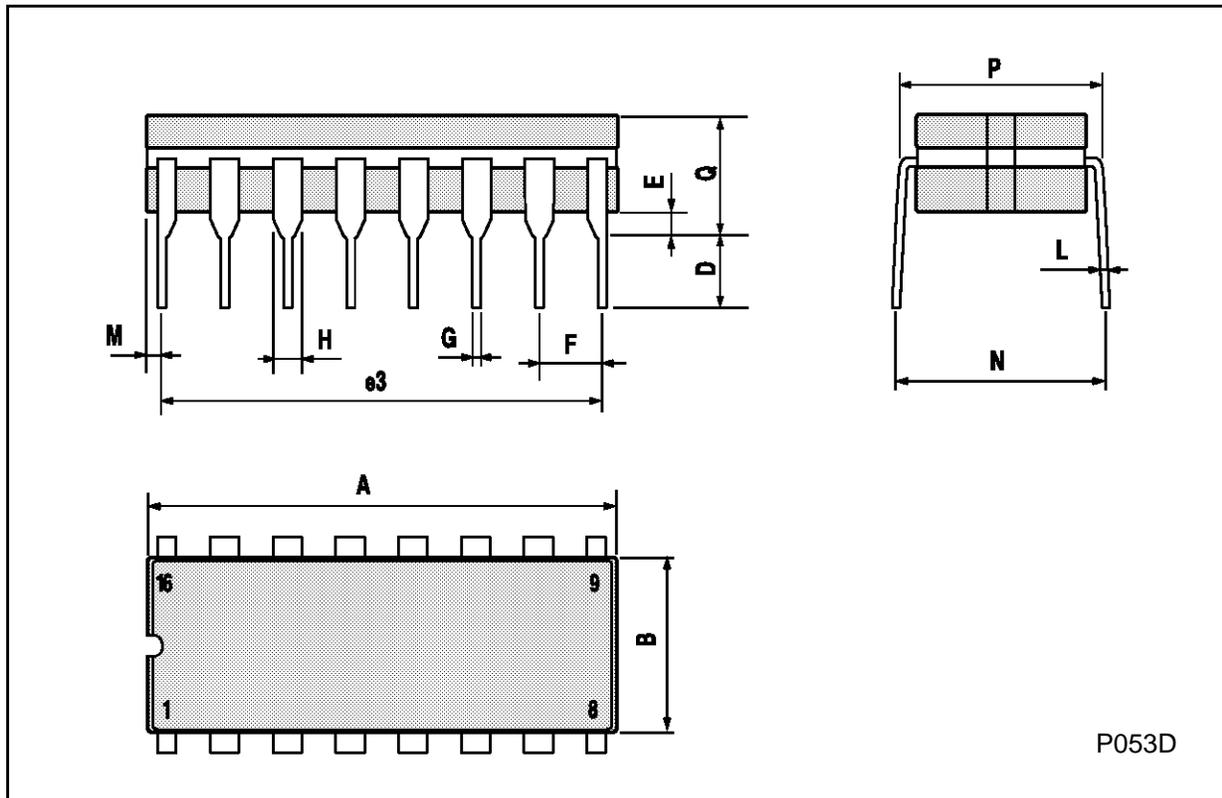
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



P001C

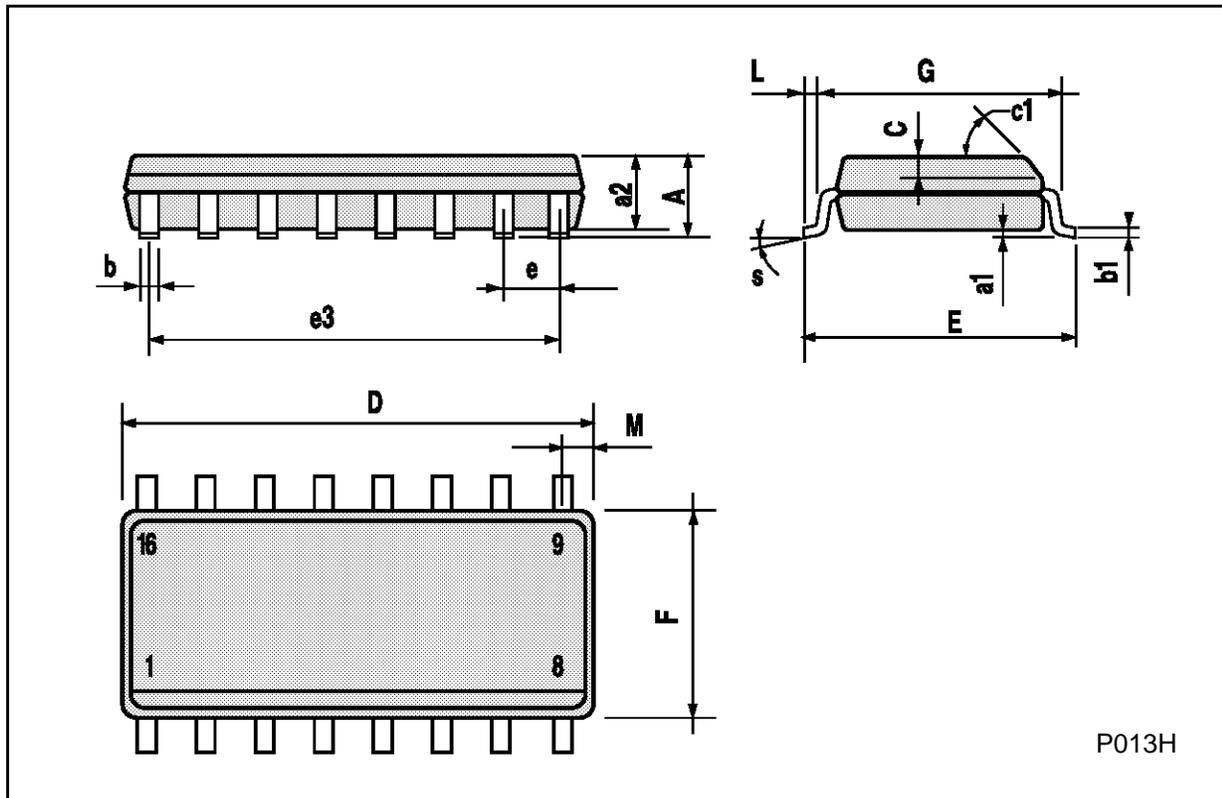
Ceramic DIP16/1 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			20			0.787
B			7			0.276
D		3.3			0.130	
E	0.38			0.015		
e3		17.78			0.700	
F	2.29		2.79	0.090		0.110
G	0.4		0.55	0.016		0.022
H	1.17		1.52	0.046		0.060
L	0.22		0.31	0.009		0.012
M	0.51		1.27	0.020		0.050
N			10.3			0.406
P	7.8		8.05	0.307		0.317
Q			5.08			0.200



SO16 (Narrow) MECHANICAL DATA

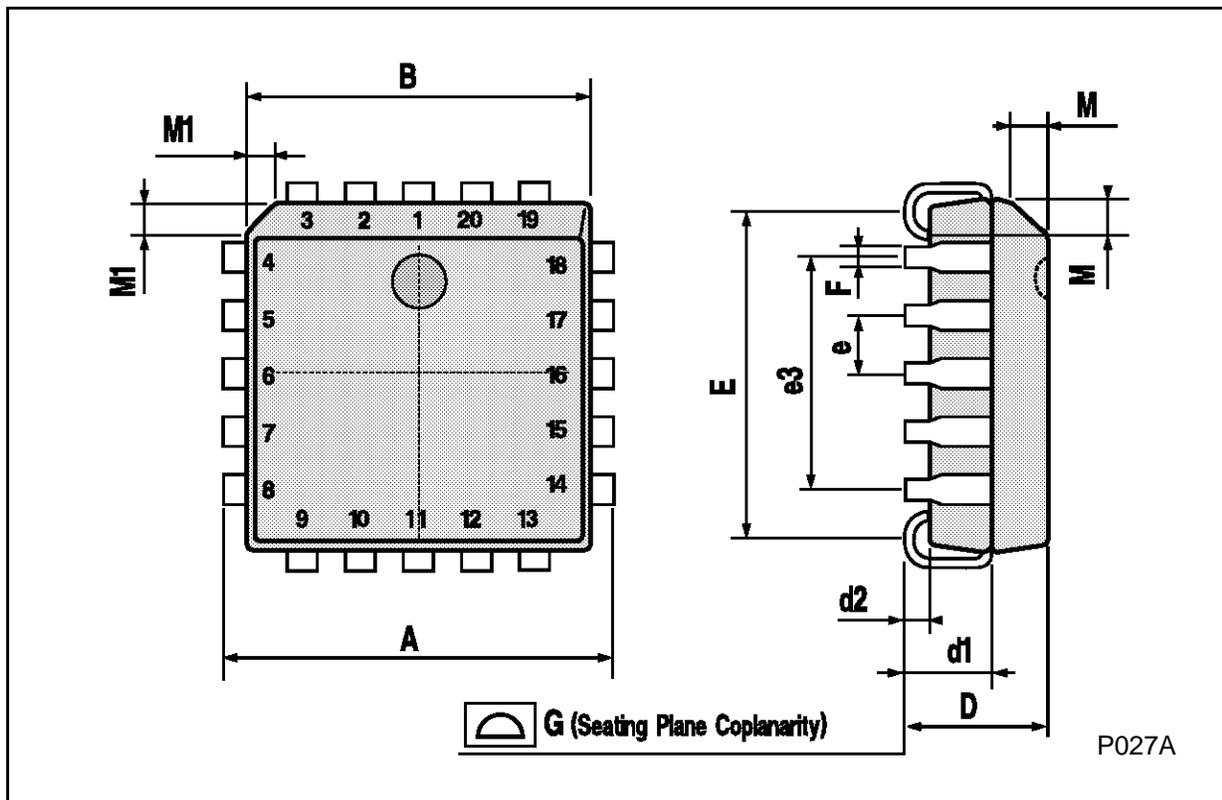
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.004		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8° (max.)					



P013H

PLCC20 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	9.78		10.03	0.385		0.395
B	8.89		9.04	0.350		0.356
D	4.2		4.57	0.165		0.180
d1		2.54			0.100	
d2		0.56			0.022	
E	7.37		8.38	0.290		0.330
e		1.27			0.050	
e3		5.08			0.200	
F		0.38			0.015	
G			0.101			0.004
M		1.27			0.050	
M1		1.14			0.045	



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